

HEAD OF DELEGATION (HoD) REPORT

U.S. Member Body of the International Organization for Standardization (ISO)



U.S. National Committee of the International Electrotechnical Commission (IEC)

Please return this report within one month of the completion of the international meeting and submit it to the appropriate ANSI Department as follows:

ISO

USNC

ISOT@ansi.org

USNC@ansi.org

HoD reports can be used for a variety of purposes. For example:

- ❖ To report results of a TC/SC meeting to the related TAG
- To publicize the work of the TC/SC to the related US constituency via ANSI On-line, USNC News and Notes, or other media
- To suggest areas for possible development of featured articles
- To address specific challenges and concerns that the HoD may bring to the attention of related ANSI and/or USNC/IEC management

PLEASE REMEMBER: Your HoD report is NOT filed as a confidential, password protected document and, therefore, may have broad, unintended distribution. Keep this in mind when preparing the report and, if appropriate, use a more secure form of correspondence to call attention to any sensitive issues.

Completed by:

Head of Delegation: (Please print)	Dennis Oddsen
Telephone/Telefax:	475-882-4605
Email:	doddsen@hubbell.com
Date:	December 6 , 2016

Meeting of	SC 23K / ELECTRICAL ENERGY EFFICIENCY PRODUCTS
(Designation/Title)	
Date(s) October 11	1, 2016
Location Frankfu	rt, Germany

1.	MEETING ATTENDANCE
	Please indicate, if available, both the number of delegates and the countries represented at the Meeting:
	Approximately 32 delegates representing 19 Countries were present.
	Meeting attendance roster and meeting resolutions attached, if available
	Please comment on significant or unusual attendance issues (e.g., new member bodies, regular members not in attendance, new Chairman or Secretariat, non-accredited U.S. persons, etc.).
	None to report
	MEETING OBSERVATIONS
2.	Overall, how well did the U.S. meet its objectives on policy or technical matters?
	 Very Successful U.S. positions were accepted in whole Successful Compromises were reached which are acceptable to the U.S. Not Successful U.S. positions were not accepted
3.	Please comment on any issues of significance which might have an impact upon materially affected or interested U.S. parties.
	(1) Report from the WG 1 of SC 23 K was provided. A CD issued for IEC 62962 Particular Requirements Load Shedding Equipment. SC 23 K WG 1 has responsibility for the development of this standard.
	(2) WG 1 covers development of requirements and testing procedures for Energy Efficiency products, devices and solutions used within an efficient Management system of Electrical Energy. The products covered can contribute to monitor, measure, and control to manage and optimize the overall efficient use of a.c. or d.c. electrical energy for household and similar locations.
	(3) Reviews of progress of work and planned program of work for activities in 2017 were discussed.
	(4) The US does not directly participate in WG 1.
4.	Was there any discussion for which the United States was unprepared? (e.g., late document distribution, addition of new items, etc.) None

5.	Did the U.S. extend an offer to assume any new TC/SC Secretariat or management positions?					
	Yes \underline{X} (If yes, please indicate which position	No on and provide Officer contact information.)				
6.	Did the U.S. extend an offer to host a	ny future TC/SC meetings?				
	Yes X If yes, please identify:	No				
7.		quire, or might involve, coordination with ation items with other U.S. TAGs, ANSI policy-level MC and/or Council, etc.)				
	Yes X If yes, please identify:	No				
8.	Did the U.S. put forth/agree to put for	orth any New Work Items?				
	Yes \underline{X} If yes, please identify:	No				
9.	Was there any evidence of irregular	voting by participating countries?				
	Yes $\underline{\underline{X}}$ If yes, please identify any significan	No t issues or concerns:				
10.		ng affected by related work in regional LEC, ETSI, PASC, NAFTA, COPANT, etc.)?				
	Yes X No related regional activity If yes, please explain:	No				
11.	Were any new issues raised which re emerging market countries?	equire, or might involve, coordination with				
	Yes X If yes, please explain:	No				

12.	Were any issues raised which relate to or impact existing U.S. regulatory matters?
	Yes X No If yes, please explain:
13.	Please identify any IMMEDIATE U.S. TAG actions which will be required as a result of this international meeting.
	None
14.	Places identify angelfic designer which the U.S. delegation believes to be not away by for
14.	Please identify specific decisions which the U.S. delegation believes to be noteworthy for publication, publicity and/or development of a future article. If there are any, would you be willing to help develop an article for publication?
	Yes <u>X</u> No
15.	What might be done to further promote the ANSI Federation's goal of "global standards that reflect U.S. interests?" (Consider such issues as how might the U.S. further promote acceptance of related American National Standards in international and, where applicable, regional fora?)
	None to report
16.	Has this report been provided to your TAG Administrator for US TAG distribution?
	X Yes _ No
17. inclu	Do you have any questions, comments, or suggestions regarding the ISO/IEC Directives, ding the IEC Supplement?
	None
18.	Other Comments
	None

May 2016



23K(Frankfurt/Sec)01

For IEC use only

2016-10-11

INTERNATIONAL ELECTROTECHNICAL COMMISSION

Attendance List for the SC23K meeting to be held in Frankfurt on 10 October 2016

National Committee	Role	<u>Last Name</u>	First Name	Signature
Belarus	Delegate	Kabanau	Siarhei	
Belgium	TC 23 Secretary	De Kesel	Wim	
Belgium	Head of delegation	Haentjens	Rony	
Cambodia	Delegate	Leng	Sok	
Cambodia	Delegate	Tonat	Pen	
China	Delegate	Zhang	Lili	
China	Head of delegation	Li	hui	
Côte D'Ivoire	Delegate	N'GORAN	Konan Norbert	
Denmark	Head of delegation	Malskaer	Flemming	
Denmark	Delegate	Nielsen	Ole Albert	
Denmark	Delegate	Damgaard	Peter	

National Committee	Role	Last Name	First Name	Signature
France	Other participation	Bravais	Nadine	
France	Delegate	Doyen	Olivier	
France	Head of delegation	Rey	Jean-François	
France	Secretary	Vollet	Philippe	
Germany	Delegate	Monaco	Antonio	
Germany	Delegate	Blosfeld	Uwe	
Germany	Delegate	Hauck	Johannes	
Germany	Head of delegation	Hof	Bernhard	
Germany	TC 23 Chair	Ziebell	Claus-Dieter	
Honduras	Delegate	CANALES MARTINEZ	Jose Jorge	
IEC Central Office	Technical Officer	Lee	Damien	
Indonesia	Delegate	Soemarjanto	Soemarjanto	
Italy	Chair	Gavazzeni	Matteo	
Italy	Liaison	Tomasina	Stefano	
Japan	Head of delegation	Kitagawa	Katsunori	
Japan	Delegate	Kusama	Kimio	
Jordan	Delegate	Al Nsour	Mohammed	
Jordan	Delegate	Alhejazin	Sawsan	

National Committee	Role	Last Name	First Name	Signature
Mexico	Head of delegation	Jiménez	María de Jesús	Signature
Morocco	Delegate	Hajji	Safaa	
Saudi Arabia	Delegate	alohaly	abdulhameed	1
South Africa	Delegate	Mtombeni	John	
Spain	Delegate	Garcia Rubio	Concepción	
Spain	Head of delegation	Novel	Beatriz	
Sweden	Head of delegation	Eriksson	Ingvar	
Switzerland	Delegate	Sollberger	Armin	
United Arab Emirates	Delegate	Al Kokhardi	Hana	
United Arab Emirates	Delegate	Al Ali	Abdelrahman	
United Arab Emirates	Delegate	Al Hammadi	Asma	
United Kingdom	Delegate	Hill	Roland	
United Kingdom	Delegate	Willmore	Stephen R.	
United Kingdom	Delegate	Bird	Norman	
United Kingdom	Head of delegation	Mullins	Malcolm H.	

National Committee	Role	<u>Last Name</u>	First Name	<u>Signature</u>
United States of America	Head of delegation	Oddsen	Dennis	Signature
United States of America	Delegate	Kurten	Charles (Chuck)	
United States of America	Delegate	Gettman	Kenneth	
Zambia	Delegate	Malama	Joseph	
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